PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | |
|----------------------|----------------|---|
| 1.1 Company | life.augmented | STMicroelectronics International N.V |
| 1.2 PCN No. | | POWER AND DISCRETES/25/15524 |
| 1.3 Title of PCN | | 8 inches Wafer Diameter Conversion for ESDA25L at ST Tours (France) and Qualification of new Molding Compound |
| 1.4 Product Category | | ESDA25L |
| 1.5 Issue date | | 2025-07-24 |

| 2. PCN Team | | |
|---------------------------|-------------------------|--|
| 2.1 Contact supplier | | |
| 2.1.1 Name | KRISZTINA NEMETH | |
| 2.1.2 Phone | +49 89460062210 | |
| 2.1.3 Email | krisztina.nemeth@st.com | |
| 2.2 Change responsibility | | |
| 2.2.1 Product Manager | Stephane CHAMARD | |
| 2.1.2 Marketing Manager | Philippe LEGER | |
| 2.1.3 Quality Manager | Jean-Paul REBRASSE | |

| 3. Change | | |
|---------------------------------|---------------------------------|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| Manufacturing reshaping program | Manufacturing reshaping program | 6inch ST Tours (France) |

| 4. Description of change | | |
|---|-------------------------|-------------------------|
| Old New | | New |
| 4.1 Description | 6inch ST Tours (France) | 8inch ST Tours (France) |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No impact | |

| 5. Reason / motivation for change | | |
|-----------------------------------|--|--|
| | Following Corporate PCI 15383 (Early Notification), about Company reshaping program, please be informed that Die manufacturing line in 6 inches at ST Tours (France) for ESDA25L will be converted to 8 inches wafer diameter and Molding Compound will be changed at one subcontractor. | |
| 5.2 Customer Benefit | SERVICE CONTINUITY | |

| 6. Marking of parts / traceability of change | | |
|--|--|--|
| | Traceability of the change will be ensured by Finished Good/Type (Beginning with O letter) printed on carton labels. | |

| 7. Timing / schedule | | |
|-------------------------------------|--------------|--|
| 7.1 Date of qualification results | 2026-04-30 | |
| 7.2 Intended start of delivery | 2026-07-31 | |
| 7.3 Qualification sample available? | Upon Request | |

| 8. Qualification / Validation | | | |
|--|-------------|---------------|--|
| 8.1 Description | | | |
| 8.2 Qualification report and qualification results | In progress | Issue Date | |

| | 9. Attachments (additional documentations) |
|---|--|
| 15524 Public product.pdf 15524 Filtre with new resin.pdf | |

| 10. Affected parts | | |
|---|---------|--------------------------|
| 10. 1 Current | | 10.2 New (if applicable) |
| 10.1.1 Customer Part No 10.1.2 Supplier Part No | | 10.1.2 Supplier Part No |
| | ESDA25L | |

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